

Insulated Gate Bipolar Transistor Ultralow V_{CE(on)}, 342 A



SOT-227

PRODUCT SUMMARY				
V _{CES}	600 V			
V _{CE(on)} (typical) at 200 A, 25 °C	1.33 V			
I_C at $T_C = 97$ °C ⁽¹⁾	200 A			

Note

(1) Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

FEATURES

 Standard: Optimized for minimum saturation voltage and low speed up to 5 kHz



Ro

- Lowest conduction losses available
- Fully isolated package (2500 V_{AC})
- Very low internal inductance (5 nH typical)
- Industry standard outline
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, TIG welding, induction heating
- Easy to assemble and parallel
- · Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{CES}		600	V	
Ocation of a lighter comment	ı (1)	T _C = 25 °C	342		
Continuous collector current	I _C ⁽¹⁾	T _C = 97 °C	200		
Pulsed collector current	I _{CM}	Repetitive rating; $V_{GE} = 20 \text{ V}$, pulse width limited by maximum junction temperature See fig. 15	400	А	
Clamped Inductive load current	I _{LM}	$V_{CC} = 80 \% (V_{CES}), V_{GE} = 20 V,$ $L = 10 \ \mu H, R_g = 2.0 \ \Omega,$ See fig. 14	400		
Gate to emitter voltage	V _{GE}		± 20	V	
Reverse voltage avalanche energy	E _{ARV}	Repetitive rating; pulse width limited by maximum junction temperature	155	mJ	
RMS isolation voltage	V _{ISOL}	Any terminal to case, t = 1 minute	2500	V	
Maximum power dissipation	-	T _C = 25 °C	781	W	
	P _D	T _C = 100 °C	312		
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	
Mounting torque		6-32 or M3 screw	12 (1.3)	lbf ⋅ in (N ⋅ n	

Note

 $^{(1)}$ Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER SYMBOL TYP. MAX.		UNITS			
Junction to case	R _{thJC}	-	0.16	°C/W	
Case to sink, flat, greased surface	R _{thCS}	0.05	-	C/VV	
Weight of module		30	-	g	

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GA200SA60SP

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$		600	-	-	V
Emitter to collector breakdown voltage	V _{(BR)ECS} (1)	$V_{GE} = 0 \text{ V}, I_{C} = 1.0 \text{ A}$	V _{GE} = 0 V, I _C = 1.0 A		-	-]
Temperature coeff. of breakdown voltage	$\Delta V_{(BR)CES}/\Delta T_{J}$	$V_{GE} = 0 \text{ V}, I_{C} = 1.0 \text{ mA}$		ı	0.62	-	V/°C
Collector to emitter saturation voltage V ₀	V _{CE(on)}	I _C = 100 A	V _{GE} = 15 V See fig. 2, 5	-	1.10	1.3	- V
		I _C = 200 A		-	1.33	-	
		I _C = 100 A, T _J = 150 °C		-	1.02	-	
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$		3.0	-	6.0	
Temperature coeff. of threshold voltage	$\Delta V_{GE(th)}/\Delta T_{J}$	$V_{CE} = V_{GE}$, $I_C = 2 \text{ mA}$		-	- 10	-	mV/°C
Forward transconductance	9fe ⁽²⁾	V _{CE} = 100 V, I _C = 100 A	١	90	150	-	S
Zero gate voltage collector current	I _{CES}	V _{GE} = 0 V, V _{CE} = 600 V		-	-	1.0	mA
		V _{GE} = 0 V, V _{CE} = 10 V,	T _J = 150 °C	-	-	10	IIIA
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V		-	-	± 250	nA

Notes

- $^{(1)}~$ Pulse width $\leq 80~\mu s;~duty~factor \leq 0.1~\%$
- $^{(2)}\,$ Pulse width 5.0 $\mu s,$ single shot

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg	I _C = 100 A	-	770	1200	nC
Gate emitter charge (turn-on)	Q _{ge}	V _{CC} = 400 V	-	100	150	
Gate collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V; See fig. 8	-	260	380	
Turn-on delay time	t _{d(on)}	T _{.1} = 25 °C	-	78	-	- ns
Rise time	t _r	$I_{\rm C} = 100 \text{A}$	-	56	-	
Turn-off delay time	t _{d(off)}	$V_{CC} = 480 \text{ V}$	-	890	1300	
Fall time	t _f	V _{GE} = 15 V	-	390	580	
Turn-on switching loss	E _{on}	R_g = 2.0 Ω Energy losses include "tail" See fig. 9, 10, 13	-	0.98	-	mJ
Turn-off switching loss	E _{off}		-	17.4	-	
Total switching loss	E _{ts}		-	18.4	25.5	
Turn-on delay time	t _{d(on)}	T_J = 150 °C I_C = 100 A, V_{CC} = 480 V V_{GE} = 15 V, R_g = 2.0 Ω Energy losses include "tail" See fig. 10, 11, 13	-	72	-	- ns
Rise time	t _r		-	60	-	
Turn-off delay time	t _{d(off)}		-	1500	-	
Fall time	t _f		-	660	-	
Total switching loss	E _{ts}		-	35.7	-	mJ
Internal emitter inductance	L _E	Between lead, and center of the die contact	-	5.0	-	nH
Input capacitance	C _{ies}	V _{GE} = 0 V	-	16 250	-	
Output capacitance	C _{oes}	V _{CC} = 30 V	-	1040	-	pF
Reverse transfer capacitance	C_res	f = 1.0 MHz; See fig. 7	-	190	-	1



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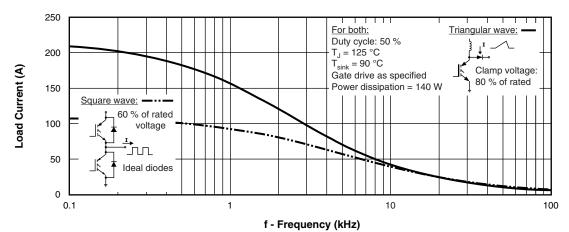


Fig. 1 - Typical Load Current vs. Frequency (Load Current = I_{RMS} of Fundamental)

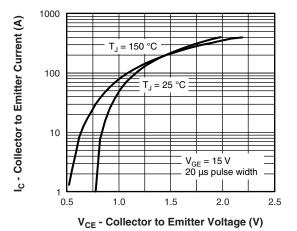


Fig. 2 - Typical Output Characteristics

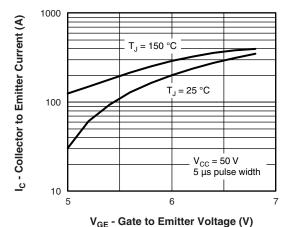


Fig. 3 - Typical Transfer Characteristics

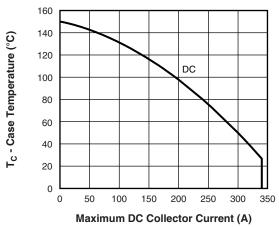


Fig. 4 - Maximum Collector Current vs. Case Temperature

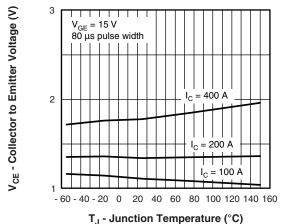


Fig. 5 - Typical Collector to Emitter Voltage vs. Junction Temperature

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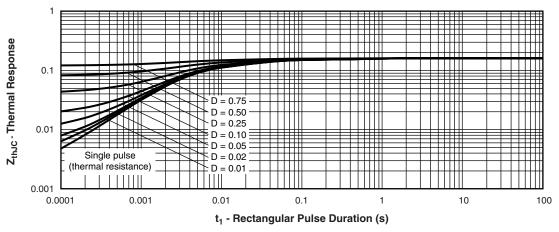


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

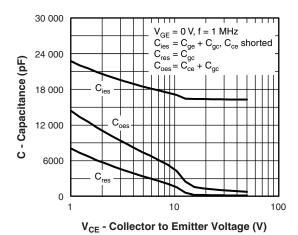


Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

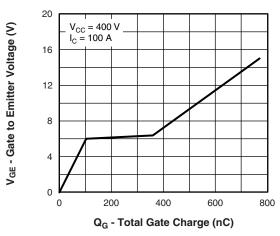


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

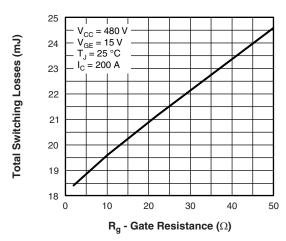


Fig. 9 - Typical Switching Losses vs. Gate Resistance

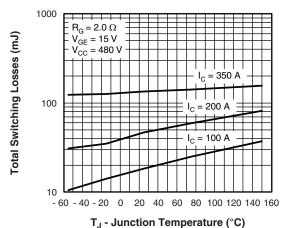


Fig. 10 - Typical Switching Losses vs.
Junction Temperature



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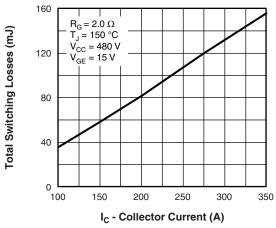
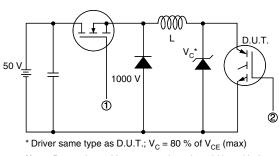


Fig. 11 - Typical Switching Losses vs. Collector Current



Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain rated ${\rm I_d}$

Fig. 13a - Clamped Inductive Load Test Circuit

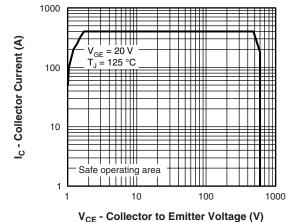


Fig. 12 - Turn-Off SOA

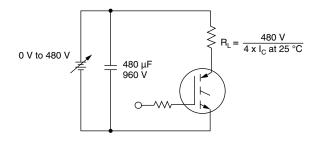


Fig. 13b - Pulsed Collector Current Test Circuit

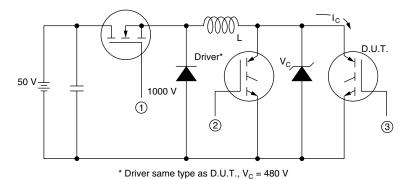


Fig. 14a - Switching Lost Test Circuit

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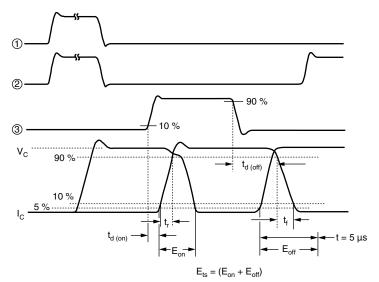
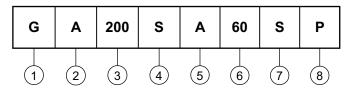


Fig. 14b - Switching Loss Waveforms

ORDERING INFORMATION TABLE

Device code



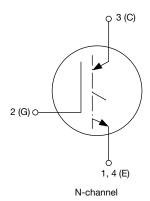
- Insulated Gate Bipolar Transistor (IGBT)
- 2 Generation 4, IGBT silicon, DBC construction
- 3 Current rating (200 = 200 A)
- 4 Single switch, no diode
- **5** SOT-227
- 6 Voltage rating (60 = 600 V)
- 7 Speed/type (S = Standard speed)
- None = Standard production
 - P = Lead (Pb)-free

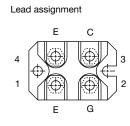


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CIRCUIT CONFIGURATION



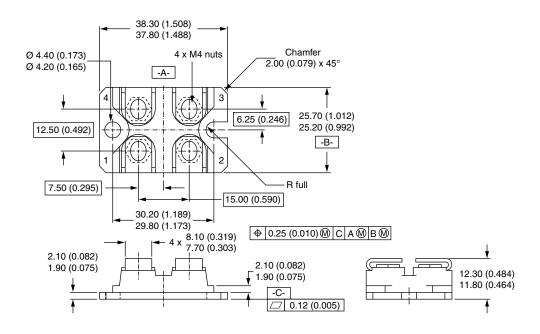


LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95036</u>				
Packaging information	www.vishay.com/doc?95037			



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DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- · Controlling dimension: millimeter

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